TOSHIBA Bipolar Digital Integrated Circuit Silicon Monolithic

TD62381FNG

8ch Low Saturation Sink Driver

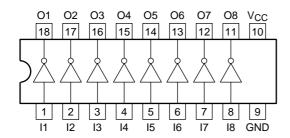
The TD62381FNG is comprised of eight NPN low saturation drivers. This device are speciffically designed for multiplexed eight driving of eight digit common-cathode LED and also can be employed as a sink driver for multiplexed LED displays using with the TD62785FN at standard supply voltage, 5 V.

Applications include relay, hammer, lamp and LED display drivers.

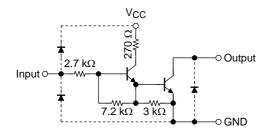
Features

- Package type: SSOP18 pin
- Low saturation output: V_{CE} (sat) = 0.9 V (max)@ I_{OUT} = 500 mA
- Output rating: V_{OUT} = 15 V (min)
- Input compatible with TTL and 5 V CMOS
- Low level active inputs
- Standard supply voltage

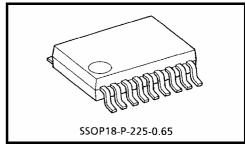
Pin Assignment (top view)



Schematics (each driver)



Note: The input and output parasitic diodes cannot be used as clamp diodes.



Weight: 0.09 g (typ.)

Maximum Ratings (Ta = 25°C)

| Characteristics | Symbol | Rating | Unit | |
|---------------------------|-----------------------|---------|-------|--|
| Supply voltage | V _{CC} | 7 | V | |
| Output sustaining voltage | V _{CE} (SUS) | 15 | V | |
| Output current | lout | 500 | mA/ch | |
| Input voltage | V _{IN} | 7 | mA | |
| Input current | I _{IN} | 5 | mA | |
| Power dissipation | P _D (Note) | 0.96 | W | |
| Operating temperature | T _{opr} | -40~85 | °C | |
| Storage temperature | T _{stg} | -55~150 | °C | |

Note: On Glass Epoxy PCB ($50 \times 50 \times 1.6$ mm Cu 40%).

Recommended Operating Conditions ($Ta = -40 \sim 85$ °C)

| Characteristic | | Symbol | Test Condition | | Min | Тур. | Max | Unit |
|-------------------|------------|-------------------------|---|------------------------|-----|------|-----------------|-------|
| Supply voltage | | V _{CC} | | | 4.5 | 5.0 | 5.5 | V |
| Output voltage | | Vout | | | _ | _ | 12 | V |
| Output current | | | DC 1 Circuit, Ta = 25°C | C 1 Circuit, Ta = 25°C | | _ | 400 | |
| | | I _{OUT} (Note) | T_{pw} = 25 ms, 8 Circuit on Ta = 85°C, T_j = 120°C | Duty = 10% | 0 | _ | 350 | mA/ch |
| | | | | Duty = 20% | 0 | _ | 215 | |
| | | V _{IN} | | | 0 | _ | Vcc | |
| Input voltage | Output on | V _{IN} (ON) | | | 2.4 | _ | V _{CC} | V |
| | Output off | V _{IN} (OFF) | | | 0 | | 0.4 | |
| Power dissipation | n | P _D (Note) | | | _ | _ | 0.4 | W |

Note: On Glass Epoxy PCB ($50 \times 50 \times 1.6$ mm Cu 40%).

Electrical Characteristics (Ta = 25°C, V_{CC} = 5 V)

| Characteristics | Symbol | Test Circuit | Test Condition | Min | Тур. | Max | Unit |
|---------------------------|----------------------|-----------------|--|-----|------|-----|-------------|
| Output leakage current | ICEX | 1 | V _{IN} = OPEN V _{OUT} = 12 V, Ta = 85°C | _ | _ | 100 | μА |
| Output saturation voltage | VCE (sat) | 2 | I _{OUT} = 500 mA | _ | _ | 0.9 | - V |
| | | | I _{OUT} = 350 mA | _ | _ | 0.7 | |
| Input current | I _{IN} (ON) | 3 | V _{CC} = 5 V, V _{IN} = 2.4 V | _ | 0.4 | 0.7 | mA |
| Input voltage (Output on) | V _{IN (ON)} | _ | V _{CC} = 5 V | _ | _ | 2.4 | ٧ |
| Supply current | Icc | 4 | $V_{CC} = V_{IN} = 5 \text{ V}$ | _ | _ | 17 | mA/ch |
| Turn-on delay | ton | - 5 | V_{OUT} = 10 V, R_L = 25 Ω C_L = 15 pF | _ | 0.1 | _ | - μs |
| Turn-off delay | tOFF |] | | _ | 1.2 | _ | |

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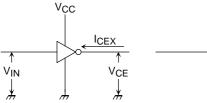
Test Circuit

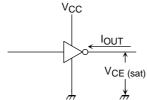
1. ICEX

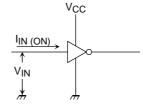
2. VCE (sat)

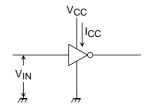
3. I_{IN} (ON)

4. Icc

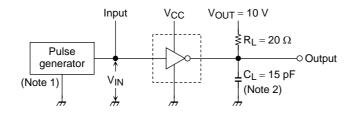


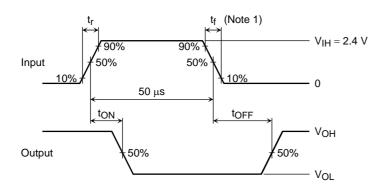






5. ton, toff





Note 1: Pulse width 50 μs, Duty cycle 10%

Output impedance 50 Ω , $t_f \le 5$ ns, $t_f \le 10$ ns

Note 2: C₁ includes probe and jig capacitance.

Precautions for Using

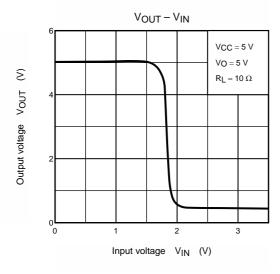
This IC does not include built-in protection circuits for excess current or overvoltage.

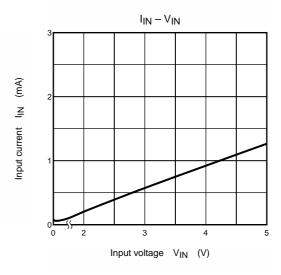
If this IC is subjected to excess current or overvoltage, it may be destroyed.

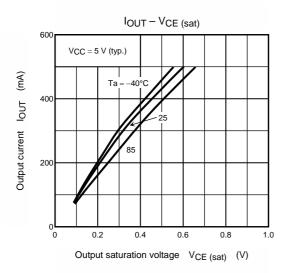
Hence, the utmost care must be taken when systems which incorporate this IC are designed.

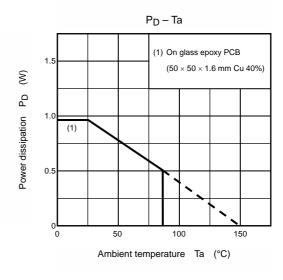
Utmost care is necessary in the design of the output line, V_{CC} , and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

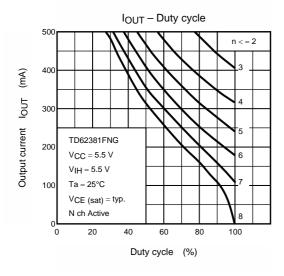
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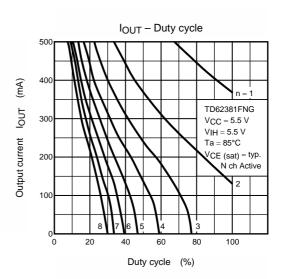






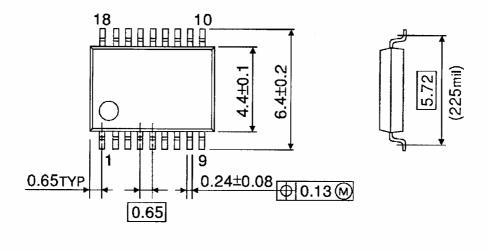


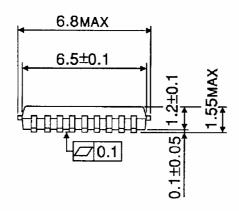


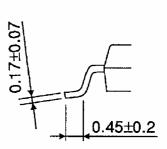


Package Dimensions

SSOP18-P-225-0.65 Unit: mm







Weight: 0.09 g (typ.)

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About solderability, following conditions were confirmed

- Solderability
 - (1) Use of Sn-63Pb solder Bath
 - solder bath temperature = 230°C
 - · dipping time = 5 seconds
 - · the number of times = once
 - · use of R-type flux
 - (2) Use of Sn-3.0Ag-0.5Cu solder Bath
 - · solder bath temperature = 245°C
 - · dipping time = 5 seconds
 - · the number of times = once
 - · use of R-type flux

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